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## 74LCX245 Low Voltage Bidirectional Transceiver with 5V Tolerant Inputs and Outputs

### Features

- 5V tolerant inputs and outputs
- 2.3V to 3.6V V<sub>CC</sub> specifications provided
- 7.0ns t<sub>PD</sub> max. (V<sub>CC</sub> = 3.3V), 10µA I<sub>CC</sub> max.
- Power down high impedance inputs and outputs
- Supports live insertion/withdrawal<sup>(1)</sup>
- $\pm 24$ mA output drive (V<sub>CC</sub> = 3.0V)
- Implements proprietary noise/EMI reduction circuitry
- Latch-up performance exceeds 500mA
- ESD performance:
  - Human body model > 2000V
  - Machine model > 200V
- Leadless DQFN package

#### Note:

 To ensure the high-impedance state during power up or down, OE should be tied to V<sub>CC</sub> through a pull-up resistor: the minimum value or the resistor is determined by the current-sourcing capability of the driver.

### **General Description**

The LCX245 contains eight non-inverting bidirectional buffers with 3-STATE outputs and is intended for bus oriented applications. The device is designed for low voltage (2.5V and 3.3V) V<sub>CC</sub> applications with capability of interfacing to a 5V signal environment. The T/R input determines the direction of data flow through the device. The  $\overline{OE}$  input disables both the A and B ports by placing them in a high impedance state.

The LCX245 is fabricated with an advanced CMOS technology to achieve high speed operation while maintaining CMOS low power dissipation.

### **Ordering Information**

| Order Number               | Package<br>Number | Package Description   |
|----------------------------|-------------------|---|
| 74LCX245WM                 | M20B              | 20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide                  |
| 74LCX245SJ                 | M20D              | 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide                               |
| 74LCX245BQX <sup>(2)</sup> | MLP20B            | 20-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, 2.5 x 4.5mm |
| 74LCX245MSA                | MSA20             | 20-Lead Shrink Small Outline Package (SSOP), JEDEC MO-150, 5.3mm Wide                       |
| 74LCX245MTC                | MTC20             | 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide                 |

#### Note:

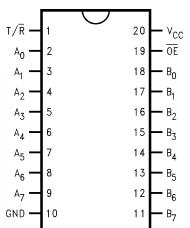
2. DQFN package available in Tape and Reel only.

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

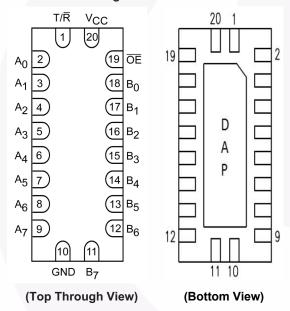
All packages are lead free per JEDEC: J-STD-020B standard.

### **Connection Diagrams**

Pin Assignments for SOIC, SOP, SSOP, and TSSOP



#### Pin Assignment for DQFN

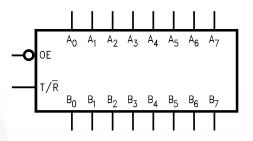


### **Pin Description**

| Pin<br>Names                   | Description                      |  |
|--------------------------------|----------------------------------|--|
| ŌĒ                             | Output Enable Input              |  |
| T/R                            | Transmit/Receive Input           |  |
| A <sub>0</sub> -A <sub>7</sub> | Side A Inputs or 3-STATE Outputs |  |
| B <sub>0</sub> –B <sub>7</sub> | Side B Inputs or 3-STATE Outputs |  |
| DAP                            | No Connect                       |  |

Note: DAP (Die Attach Pad)

### Logic Symbol



### Truth Table

| Inputs |     |   |
|--------|-----|---|
| OE     | T/R | Outputs   |
| L      | L   | Bus $B_0 - B_7$ Data to Bus $A_0 - A_7$         |
| L      | Н   | Bus $A_0 - A_7$ Data to Bus $B_0 - B_7$         |
| Н      | Х   | HIGH Z State on $A_0 - A_7$ , $B_0 - B_7^{(3)}$ |

H = HIGH Voltage Level

L = LOW Voltage Level

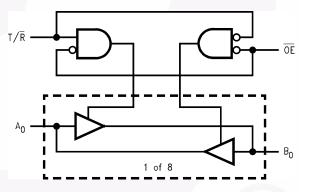
X = Immaterial

Z = High Impedance

#### Note:

3. Unused bus terminals during HIGH Z State must be held HIGH or LOW.

### Logic Diagram



### **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol           | Parameter                                    | Rating                          |
|------------------|--|---------------------------------|
| V <sub>CC</sub>  | Supply Voltage                               | –0.5V to +7.0V                  |
| VI               | DC Input Voltage                             | -0.5V to +7.0V                  |
| Vo               | DC Output Voltage                            |                                 |
|                  | Output in 3-STATE                            | -0.5V to +7.0V                  |
|                  | Output in HIGH or LOW State <sup>(4)</sup>   | –0.5V to V <sub>CC</sub> + 0.5V |
| I <sub>IK</sub>  | DC Input Diode Current, V <sub>I</sub> < GND | –50mA                           |
| I <sub>OK</sub>  | DC Output Diode Current                      |                                 |
|                  | V <sub>O</sub> < GND                         | –50mA                           |
|                  | V <sub>O</sub> > V <sub>CC</sub>             | +50mA                           |
| Ι <sub>Ο</sub>   | DC Output Source/Sink Current                | ±50mA                           |
| I <sub>CC</sub>  | DC Supply Current per Supply Pin             | ±100mA                          |
| I <sub>GND</sub> | DC Ground Current per Ground Pin             | ±100mA                          |
| T <sub>STG</sub> | Storage Temperature                          | –65°C to +150°C                 |

Note:

4. I<sub>O</sub> Absolute Maximum Rating must be observed.

### Recommended Operating Conditions<sup>(5)</sup>

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

| Symbol                            | Parameter   | Min. | Max.            | Units |
|-----------------------------------|---|------|-----------------|-------|
| V <sub>CC</sub>                   | Supply Voltage  |      |                 |       |
|                                   | Operating   | 2.0  | 3.6             | V     |
|                                   | Data Retention  | 1.5  | 3.6             |       |
| VI                                | Input Voltage   | 0    | 5.5             | V     |
| Vo                                | Output Voltage  |      |                 |       |
|                                   | 3-STATE   | 0    | 5.5             | V     |
|                                   | HIGH or LOW State                                       | 0    | V <sub>CC</sub> |       |
| I <sub>OH</sub> / I <sub>OL</sub> | Output Current  |      |                 |       |
|                                   | $V_{CC} = 3.0V - 3.6V$                                  |      | ±24             | mA    |
|                                   | $V_{CC} = 2.7V - 3.0V$                                  |      | ±12             |       |
|                                   | V <sub>CC</sub> = 2.3V–2.7V                             |      | ±8              |       |
| T <sub>A</sub>                    | Free-Air Operating Temperature                          | -40  | 85              | °C    |
| $\Delta t / \Delta V$             | Input Edge Rate, $V_{IN} = 0.8V-2.0V$ , $V_{CC} = 3.0V$ | 0    | 10              | ns/V  |

#### Note:

5. Unused inputs must be held HIGH or LOW. They may not float.

### **DC Electrical Characteristics**

|                  |                                       |                     |  | $T_A = -40^{\circ}C$  | to +85°C |       |
|------------------|---------------------------------------|---------------------|--|-----------------------|----------|-------|
| Symbol           | Parameter                             | V <sub>CC</sub> (V) | Conditions   | Min.                  | Max.     | Units |
| V <sub>IH</sub>  | HIGH Level Input Voltage              | 2.3–2.7             |  | 1.7                   |          | V     |
|                  |                                       | 2.7–3.6             |  | 2.0                   |          |       |
| V <sub>IL</sub>  | LOW Level Input Voltage               | 2.3–2.7             |  |                       | 0.7      | V     |
|                  |                                       | 2.7–3.6             |  |                       | 0.8      | ]     |
| V <sub>OH</sub>  | HIGH Level Output Voltage             | 2.3–3.6             | I <sub>OH</sub> = -100μA   | V <sub>CC</sub> – 0.2 |          | V     |
|                  |                                       | 2.3                 | I <sub>OH</sub> = -8mA   | 1.8                   |          | ]     |
|                  |                                       | 2.7                 | $I_{OH} = -12mA$   | 2.2                   |          | ]     |
|                  |                                       | 3.0                 | $I_{OH} = -18mA$   | 2.4                   |          | ]     |
|                  |                                       |                     | $I_{OH} = -24mA$   | 2.2                   |          | ]     |
| V <sub>OL</sub>  | LOW Level Output Voltage              | 2.3–3.6             | I <sub>OL</sub> = 100μA  |                       | 0.2      | V     |
|                  |                                       | 2.3                 | I <sub>OL</sub> = 8mA  |                       | 0.6      | ]     |
|                  |                                       | 2.7                 | I <sub>OL</sub> = 12mA   |                       | 0.4      | ]     |
|                  |                                       | 3.0                 | I <sub>OL</sub> = 16mA   |                       | 0.4      | ]     |
|                  |                                       |                     | $I_{OL} = 24 \text{mA}$  |                       | 0.55     |       |
| I                | Input Leakage Current                 | 2.3–3.6             | $0 \le V_I \le 5.5V$   |                       | ±5.0     | μA    |
| I <sub>OZ</sub>  | 3-STATE Output Leakage                | 2.3–3.6             | $0 \le V_O \le 5.5V,$<br>V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> |                       | ±5.0     | μA    |
| I <sub>OFF</sub> | Power-Off Leakage Current             | 0                   | $V_{\rm I}$ or $V_{\rm O} = 5.5 V$   |                       | 10       | μA    |
| I <sub>CC</sub>  | Quiescent Supply Current              | 2.3–3.6             | $V_{I} = V_{CC}$ or GND  |                       | 10       | μA    |
|                  |                                       |                     | $3.6V \le V_I, V_O \le 5.5V^{(6)}$   |                       | ±10      |       |
| $\Delta I_{CC}$  | Increase in I <sub>CC</sub> per Input | 2.3–3.6             | $V_{\rm IH} = V_{\rm CC} - 0.6V$   |                       | 500      | μA    |

#### Note:

6. Outputs disabled or 3-STATE only.

### **AC Electrical Characteristics**

|                                       | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C, R_L = 500\Omega$                             |   |                    |      |               |   |      |       |
|---------------------------------------|--|---|--------------------|------|---------------|---|------|-------|
|                                       |  | V <sub>CC</sub> = 3.3<br>C <sub>L</sub> = | 3V ± 0.3V,<br>50pF |      | 2.7V,<br>50pF | V <sub>CC</sub> = 2.5<br>C <sub>L</sub> = |      |       |
| Symbol                                | Parameter  | Min.                                      | Max.               | Min. | Max.          | Min.                                      | Max. | Units |
| t <sub>PHL</sub> , t <sub>PLH</sub>   | Propagation Delay,<br>A <sub>n</sub> to B <sub>n</sub> or B <sub>n</sub> to A <sub>n</sub> | 1.5                                       | 7.0                | 1.5  | 8.0           | 1.5                                       | 8.4  | ns    |
| t <sub>PZL</sub> , t <sub>PZH</sub>   | Output Enable Time   | 1.5                                       | 8.5                | 1.5  | 9.5           | 1.5                                       | 10.5 | ns    |
| t <sub>PLZ</sub> , t <sub>PHZ</sub>   | Output Disable Time  | 1.5                                       | 7.5                | 1.5  | 8.5           | 1.5                                       | 9.0  | ns    |
| t <sub>OSHL</sub> , t <sub>OSLH</sub> | Output to Output Skew <sup>(7)</sup>   |   | 1.0                |      |               |   |      | ns    |

Note:

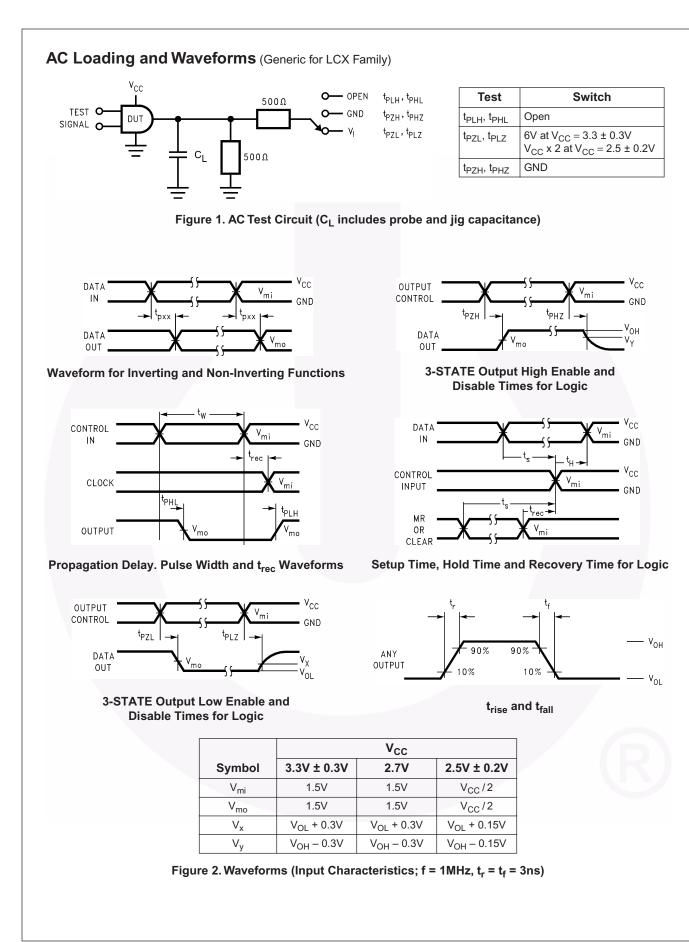
 Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t<sub>OSHL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>).

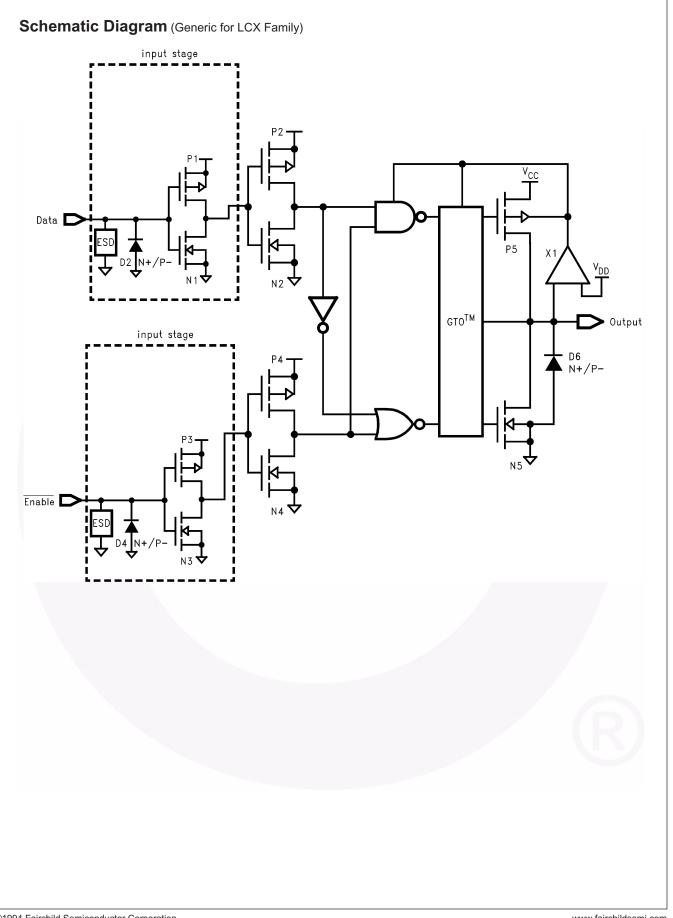
### **Dynamic Switching Characteristics**

|                  |   |                     |   | $T_A = 25^{\circ}C$ |      |
|------------------|---|---------------------|---|---------------------|------|
| Symbol           | Parameter                                   | V <sub>CC</sub> (V) | Conditions  | Typical             | Unit |
| V <sub>OLP</sub> | Quiet Output Dynamic Peak V <sub>OL</sub>   | 3.3                 | $C_L = 50 pF, V_{IH} = 3.3V, V_{IL} = 0V$         | 0.8                 | V    |
|                  |   | 2.5                 | $C_L = 30 pF$ , $V_{IH} = 2.5 V$ , $V_{IL} = 0 V$ | 0.6                 |      |
| V <sub>OLV</sub> | Quiet Output Dynamic Valley V <sub>OL</sub> | 3.3                 | $C_L = 50 pF, V_{IH} = 3.3V, V_{IL} = 0V$         | -0.8                | V    |
|                  |   | 2.5                 | $C_{L} = 30 pF, V_{IH} = 2.5V, V_{IL} = 0V$       | -0.6                |      |

### Capacitance

| Symbol           | Parameter                     | Conditions  | Typical | Units |
|------------------|-------------------------------|---|---------|-------|
| C <sub>IN</sub>  | Input Capacitance             | $V_{CC} = Open, V_I = 0V \text{ or } V_{CC}$          | 7.0     | pF    |
| C <sub>OUT</sub> | Output Capacitance            | $V_{CC} = 3.3$ V, $V_I = 0$ V or $V_{CC}$             | 8.0     | pF    |
| C <sub>PD</sub>  | Power Dissipation Capacitance | $V_{CC}$ = 3.3V, $V_{I}$ = 0V or $V_{CC}$ , f = 10MHz | 25.0    | pF    |



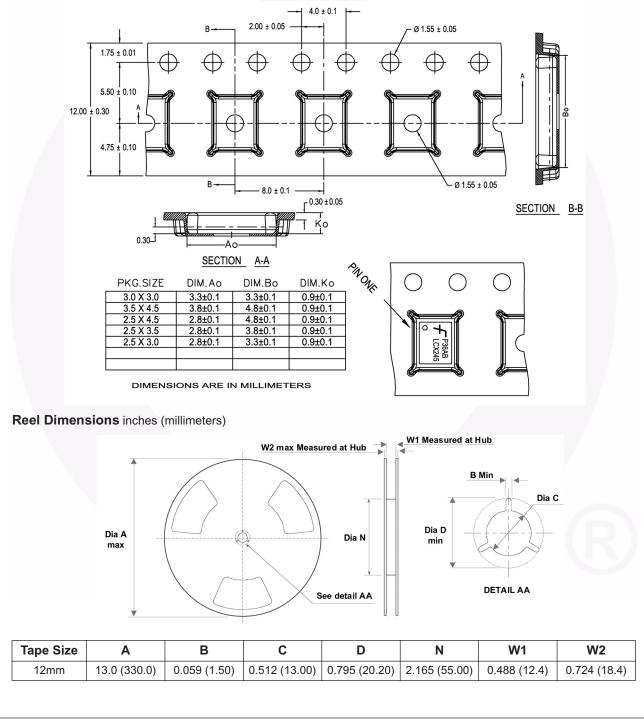


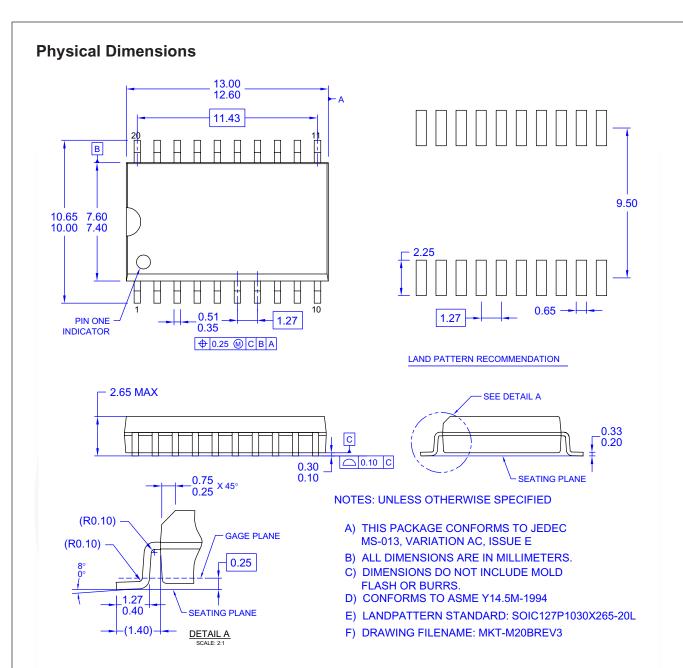
### **Tape and Reel Specification**

### Tape Format for DQFN

| Package Designator | Tape Section       | Number of Cavities | <b>Cavity Status</b> | Cover Tape Status |
|--------------------|--------------------|--------------------|----------------------|-------------------|
| BQX                | Leader (Start End) | 125 (typ.)         | Empty                | Sealed            |
|                    | Carrier            | 3000               | Filled               | Sealed            |
|                    | Trailer (Hub End)  | 75 (typ.)          | Empty                | Sealed            |

#### Tape Dimension inches (millimeters)

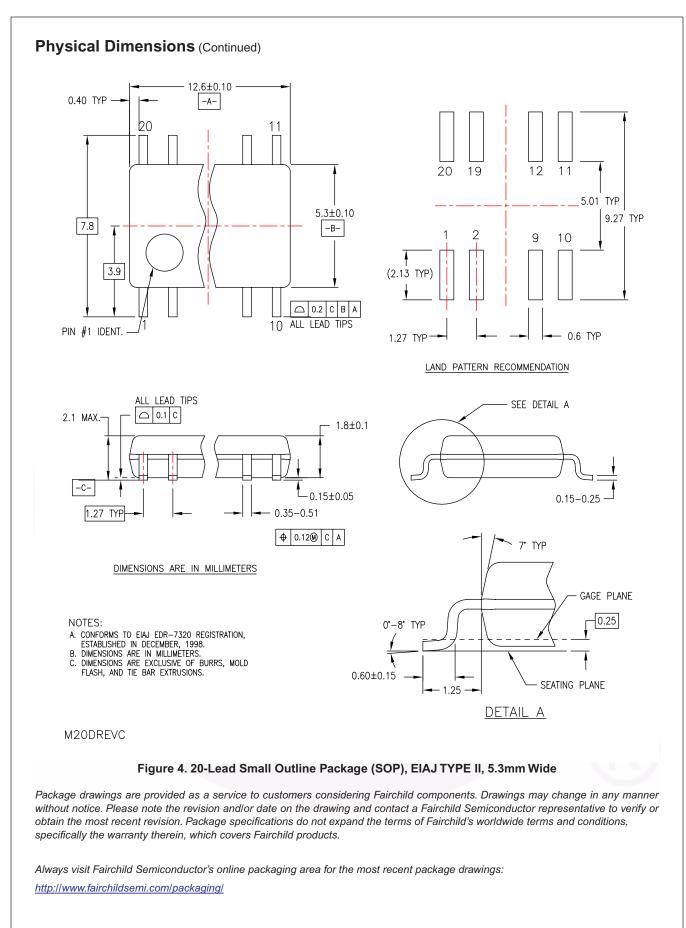


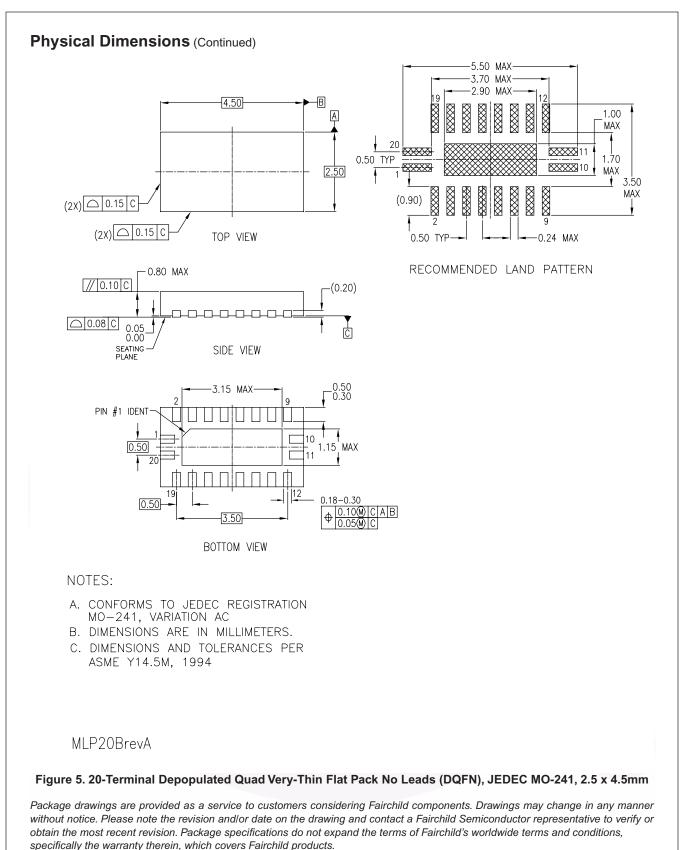


#### Figure 3. 20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide

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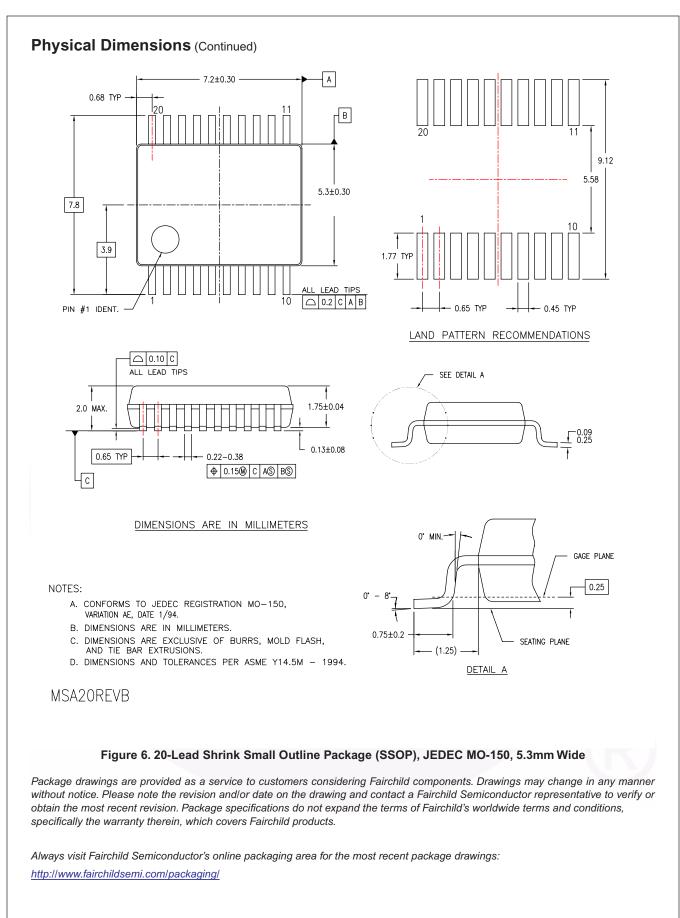


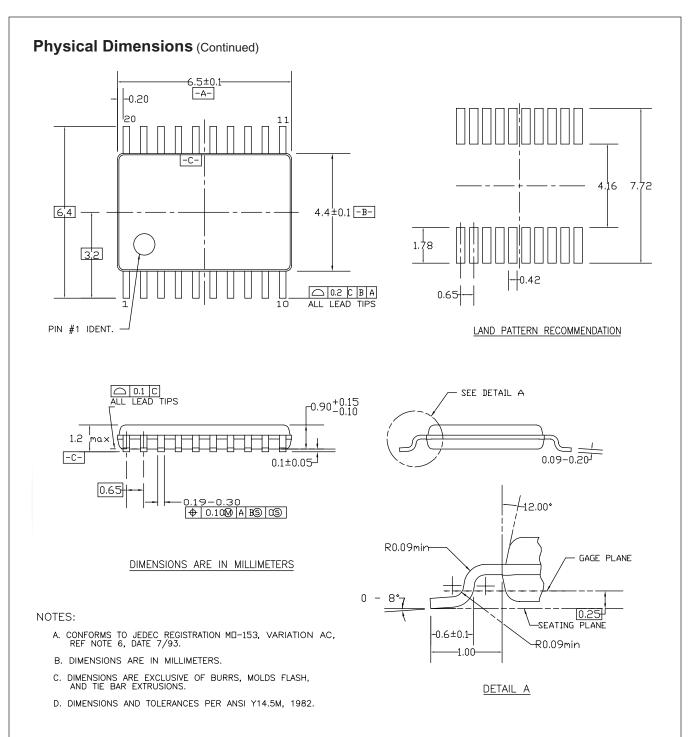


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### MTC20REVD1

#### Figure 8. 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

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| Datasheet Identification | Product Status        | Definition  |
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